

P-Channel 60-V (D-S) MOSFET

CHARACTERISTICS

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

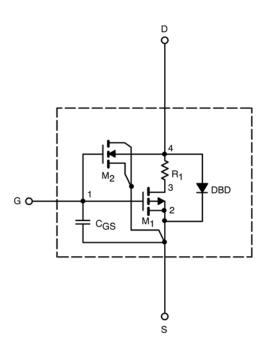
- Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-V to 10-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



SPECIFICATIONS (T_J = 25°C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static	-		-		
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS} , I_{D} = -0.25 mA	2.8		V
On-State Drain Current ^a	I _{D(on)}	V_{DS} = -10 V, V_{GS} = -10 V	2.2		А
Drain-Source On-State Resistance ^a	۲ _{DS(on)}	V_{GS} = -10 V, I _D = -500 mA	3		Ω
		V_{GS} = -4.5 V, I _D = -25 mA	4.4		
Forward Transconductance ^a	g _{fs}	V_{DS} = -10 V, I _D = -500 mA	170	180	mS
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = -200 mA, $V_{\rm GS}$ = 0 V	-0.75		V
Dynamic ^b	-				
Total Gate Charge	Qg	V_{DS} = -30 V, V_{GS} = -10 V, I_{D} = -500 mA	0.50		nC
Gate-Source Charge	Q _{gs}		0.12	0.12	
Gate-Drain Charge	Q _{gd}		0.14	0.14	

Notes

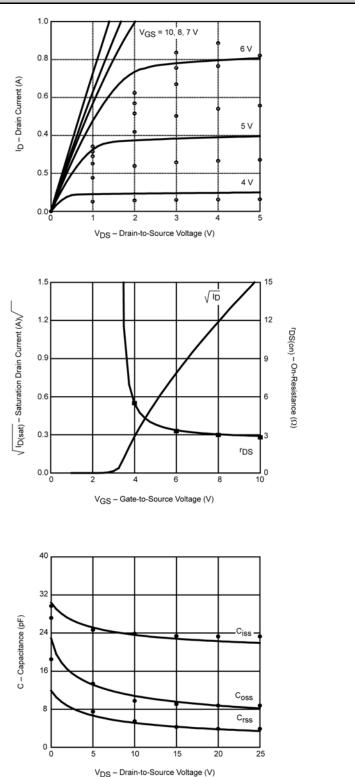
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2%. Guaranteed by design, not subject to production testing.



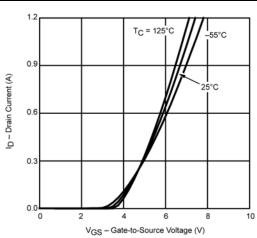
SPICE Device Model Si1025X

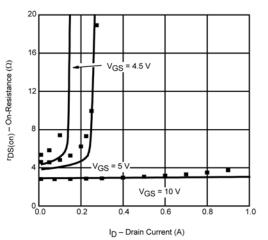
Vishay Siliconix

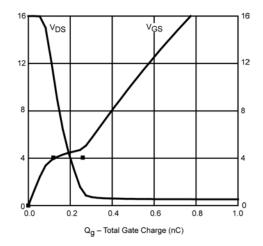
COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°C UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.







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